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(12) **United States Design Patent**
Mecchella et al.

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- (54) **ELECTRONIC DEVICE COVER**
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(US)
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- (73) Assignee: **Amazon Technologies, Inc.**, Reno, NV (US)
- (*) Notice: This patent is subject to a terminal disclaimer.
- (**) Term: **14 Years**
- (21) Appl. No.: **29/467,672**
- (22) Filed: **Sep. 20, 2013**
- (51) **LOC (10) Cl.** **14-02**
- (52) **U.S. Cl.**
USPC **D14/440**
- (58) **Field of Classification Search**
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G06F 1/1675; G06F 1/1679; G02F 1/1306;
G02F 1/133; G02F 1/133308; G02F 1/153;
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D3/218, 215, 201, 294, 289, 900;
220/4.02; 248/309.1; 361/679.56;
379/426, 433.11, 455; 455/575.1,
455/575.8, 457.1; 190/100; 206/305, 320,
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See application file for complete search history.

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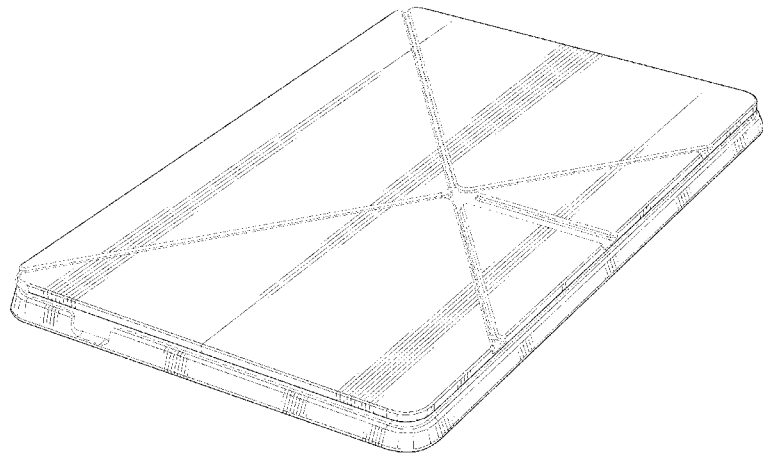
(57) **CLAIM**
The ornamental design for an electronic device cover, as shown and described.

DESCRIPTION

FIG. 1 is a first perspective view of an electronic device cover for holding an electronic device, taken from above;
 FIG. 2 is a second perspective view of the electronic device cover of FIG. 1, taken from below;
 FIG. 3 is a top plan view of the electronic device cover of FIG. 1;
 FIG. 4 is a bottom plan view of the electronic device cover of FIG. 1;
 FIG. 5 is a front elevation view of the electronic device cover of FIG. 1;
 FIG. 6 is a back elevation view of the electronic device cover of FIG. 1;
 FIG. 7 is a right-side elevation view of the electronic device cover of FIG. 1; and,
 FIG. 8 is a left-side elevation view of the electronic device cover of FIG. 1.
 The broken lines are directed to unclaimed portions and form no part of the claimed design.

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1 Claim, 6 Drawing Sheets



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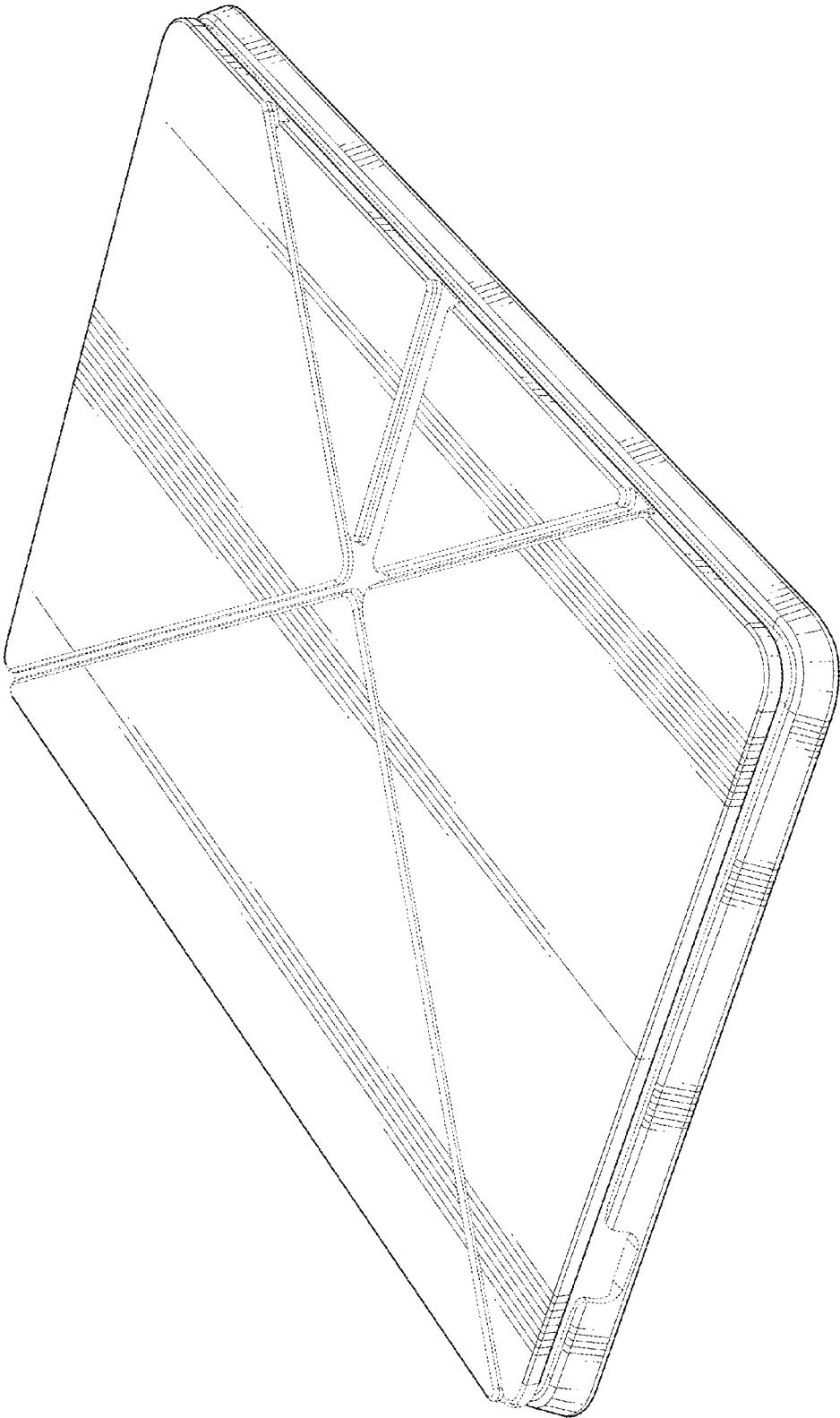


FIG. 1

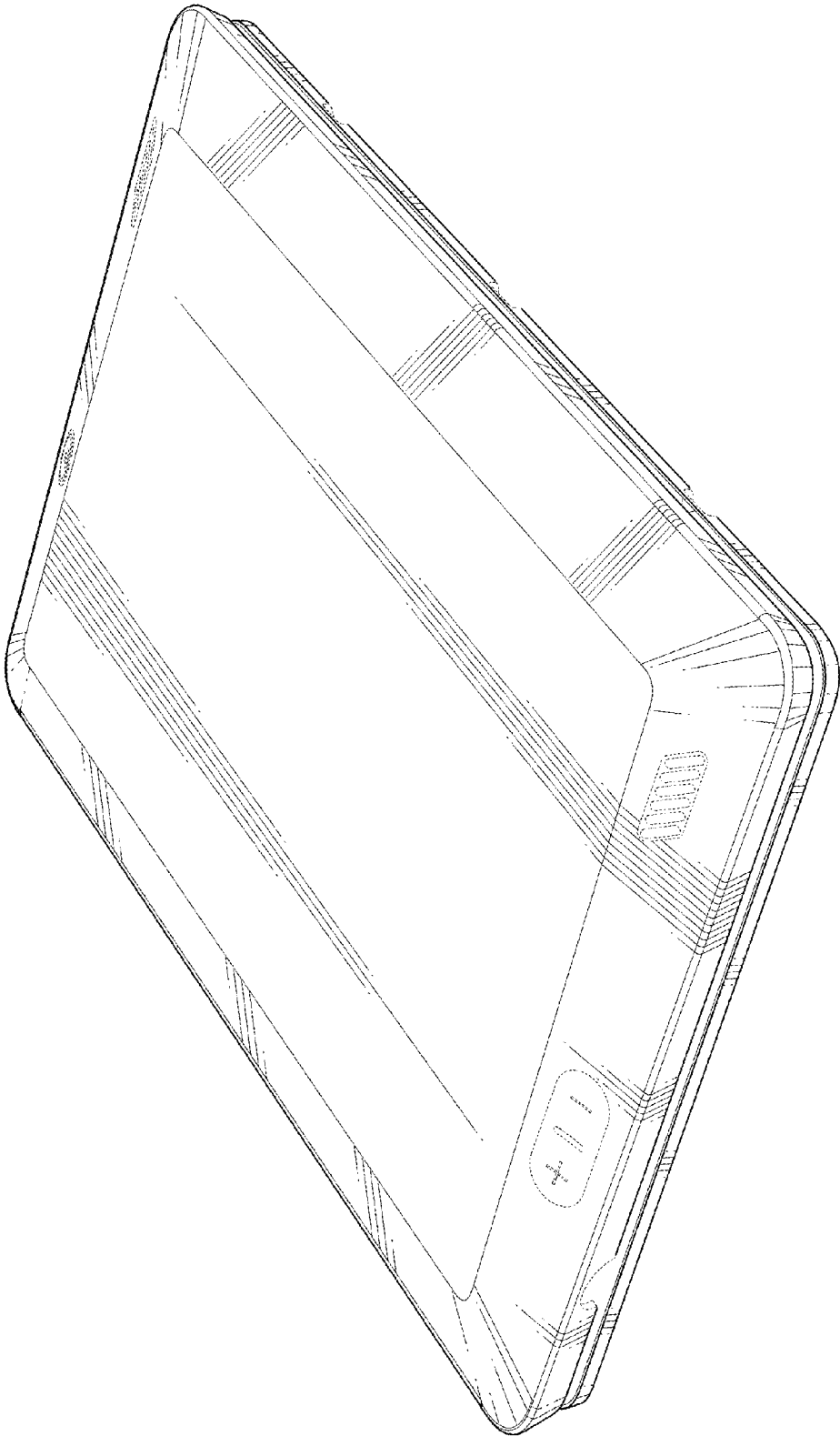


FIG. 2

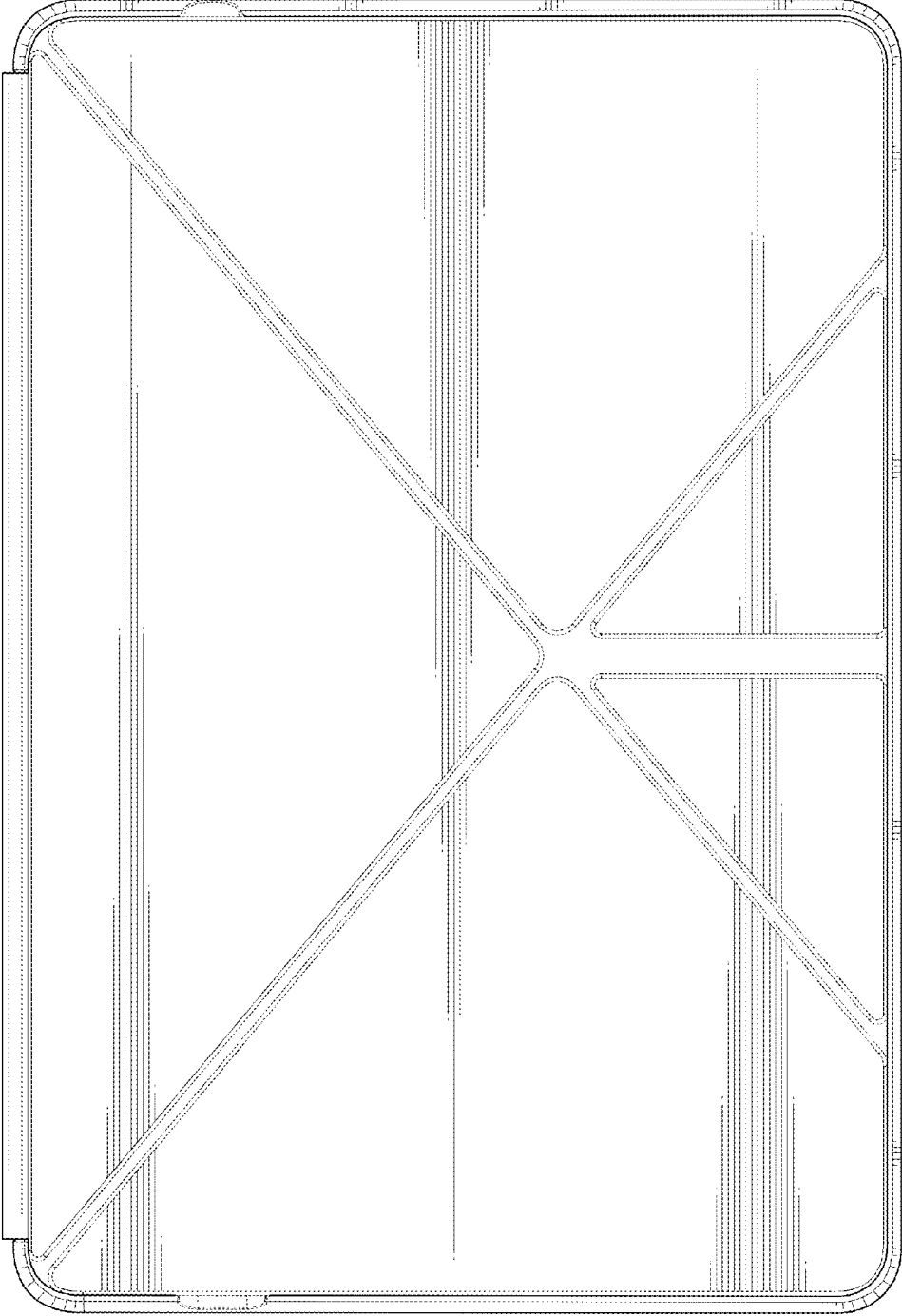


FIG. 3

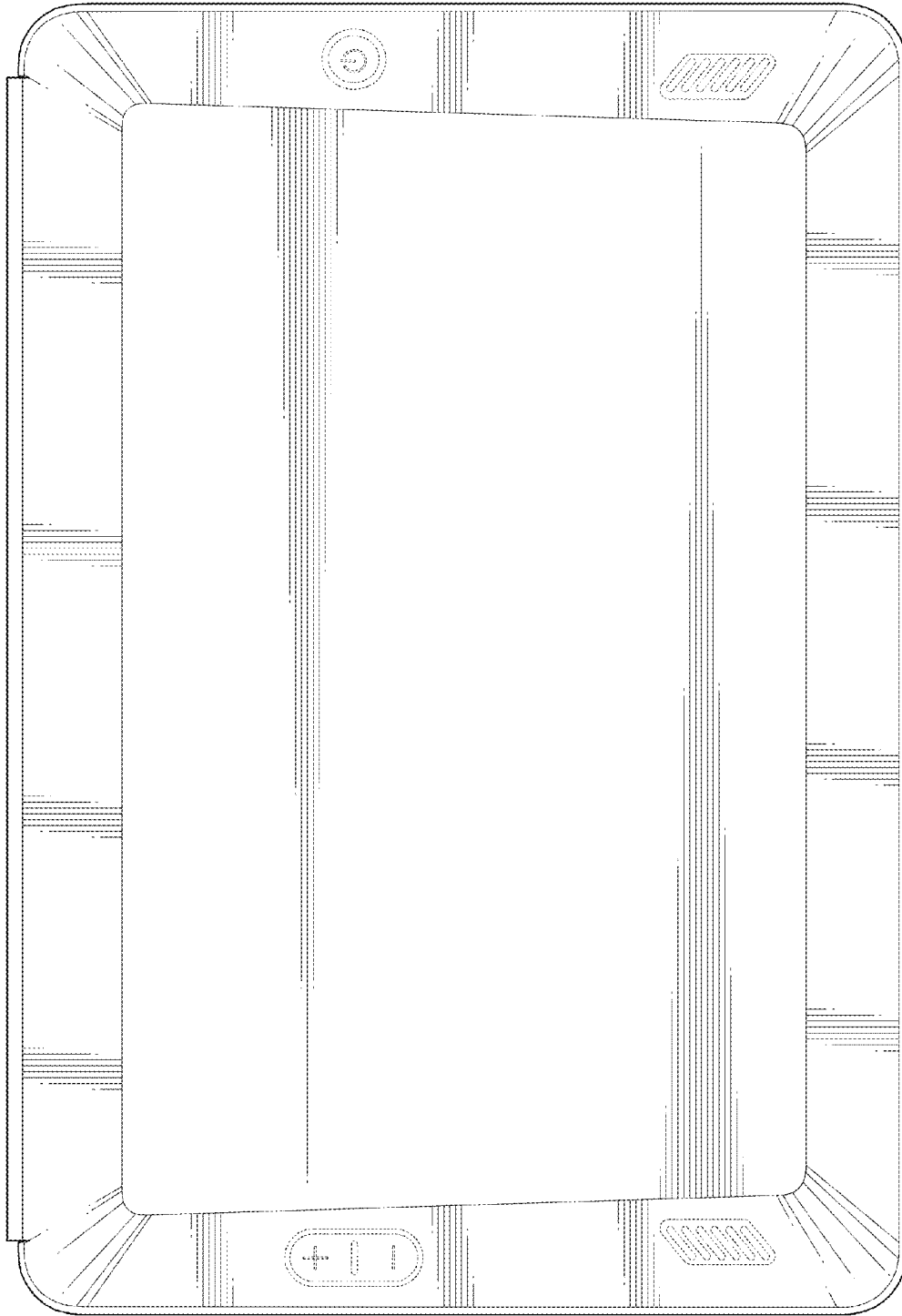


FIG. 4

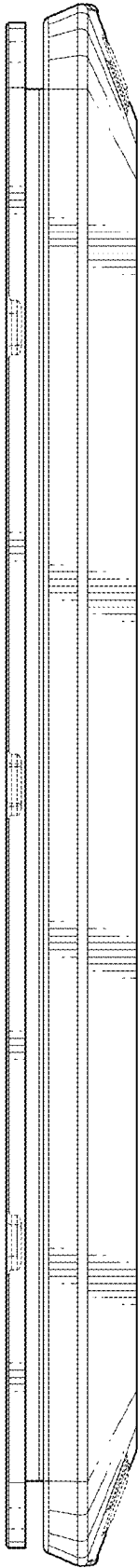


FIG. 5

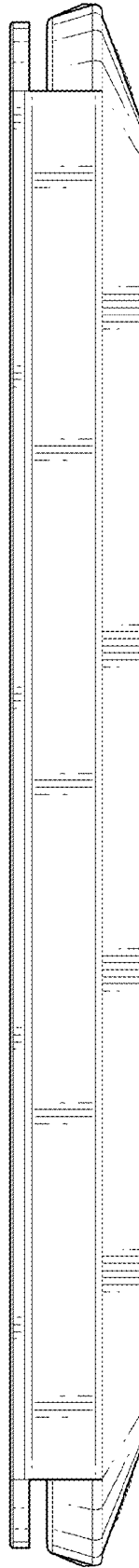


FIG. 6

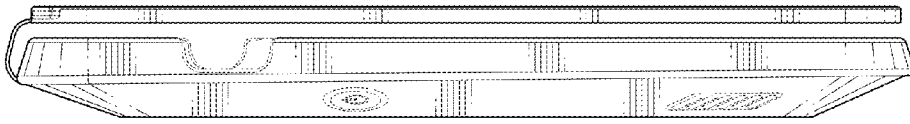


FIG. 8

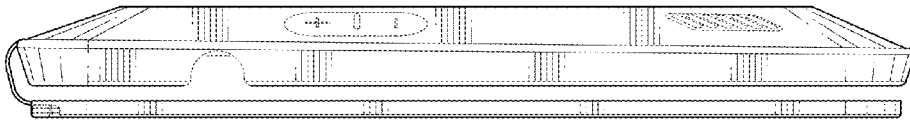


FIG. 7